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Chae

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(54) **SUBSTRATE STRUCTURE OF LIQUID CRYSTAL DISPLAY AND FABRICATION METHOD THEREOF**

(52) **U.S. Cl.** 349/95
(58) **Field of Classification Search** 349/95
See application file for complete search history.

(75) **Inventor:** **Gee Sung Chae**, Incheon (KR)

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(73) **Assignee:** **LG Display Co., Ltd.**, Seoul (KR)

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(*) **Notice:** Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 987 days.

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(21) **Appl. No.:** **11/234,132**

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Primary Examiner—James A Dudek
(74) *Attorney, Agent, or Firm*—Birch, Stewart, Kolasch & Birch, LLP

(65) **Prior Publication Data**

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(57) **ABSTRACT**

Related U.S. Application Data

(62) Division of application No. 10/260,437, filed on Oct. 1, 2002, now Pat. No. 6,989,874.

In a substrate structure and a fabrication method thereof, light refracting members aligned with wirings or black matrix formed are integrally formed at a surface of a substrate. Light incident on the wirings or the black matrix can be refracted to a pixel region of the liquid crystal display panel. Accordingly, a flux of light being transmitted through the pixel region of the liquid crystal display panel can be improved significantly.

(30) **Foreign Application Priority Data**

Dec. 29, 2001 (KR) 2001-88578

(51) **Int. Cl.**
G02F 1/1335 (2006.01)

14 Claims, 11 Drawing Sheets

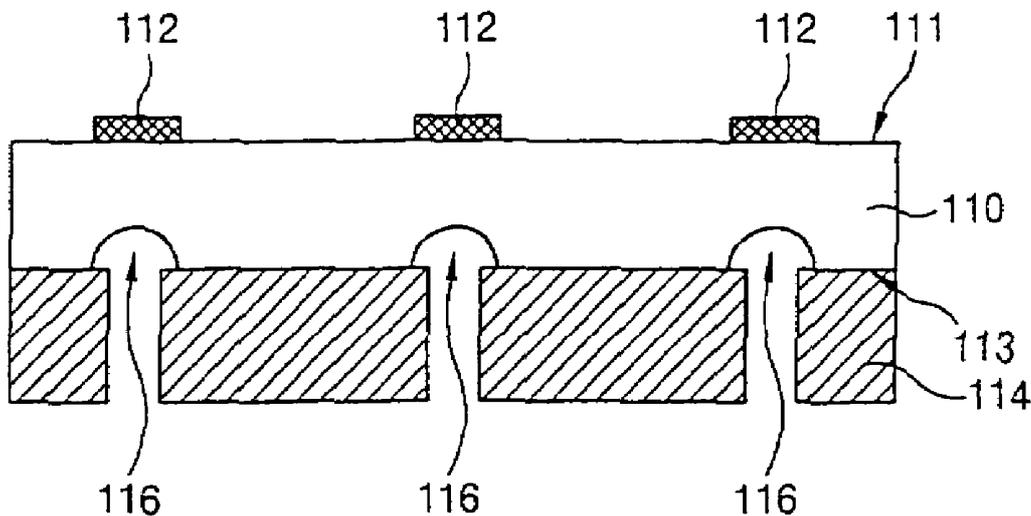


FIG. 1
CONVENTIONAL ART

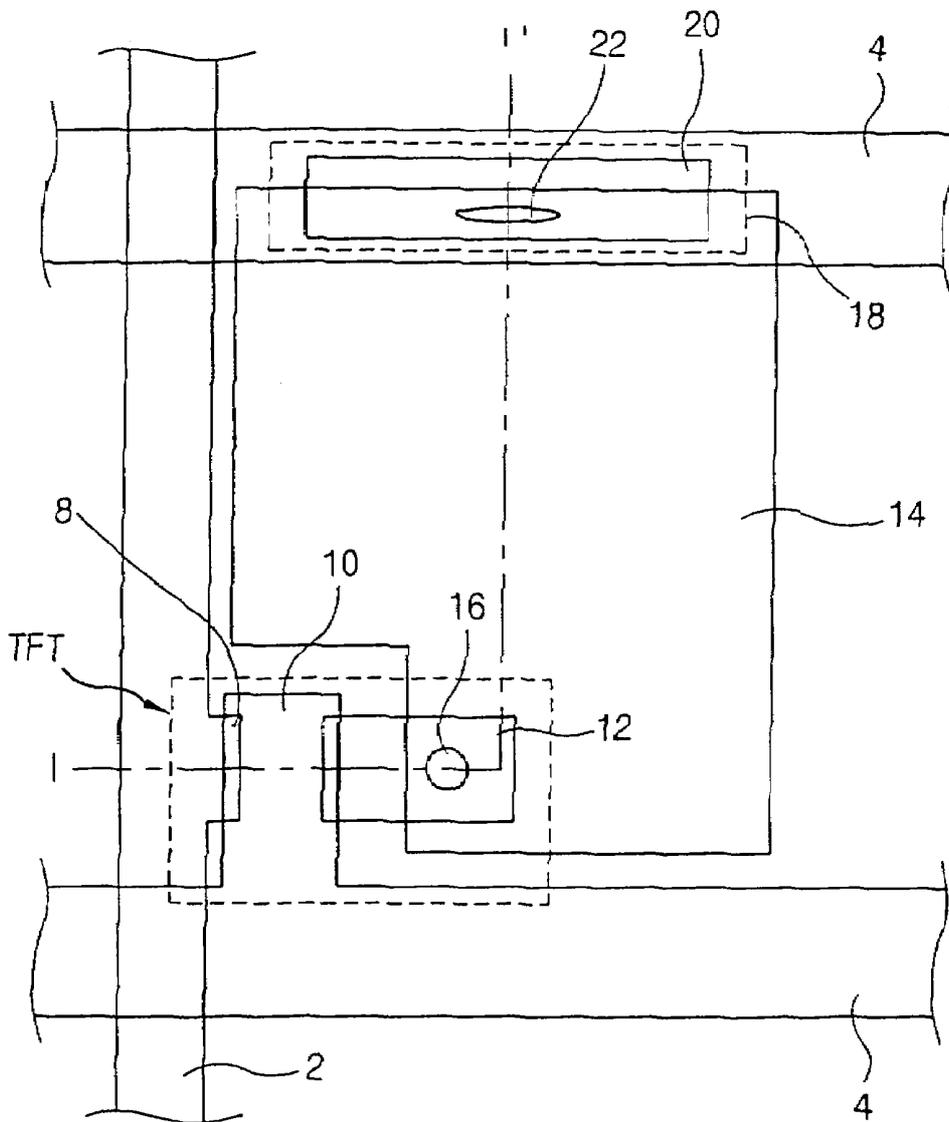


FIG. 2
CONVENTIONAL ART

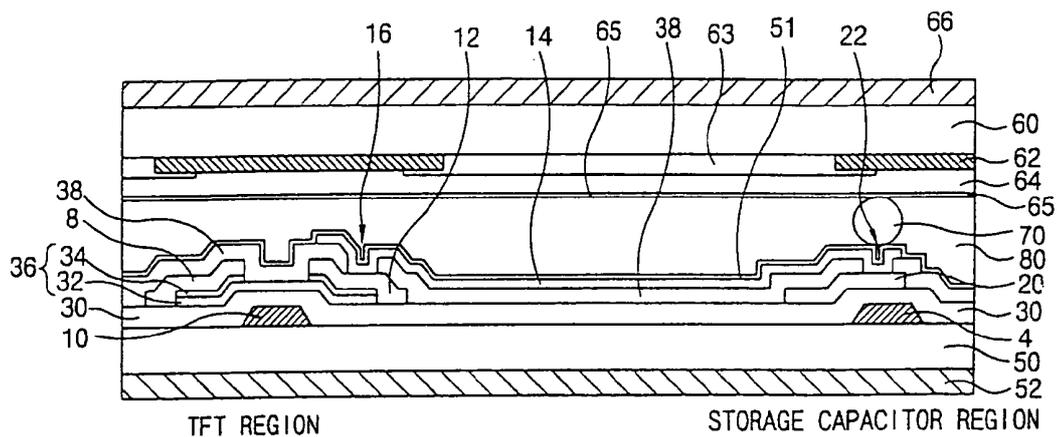


FIG. 3
CONVENTIONAL ART

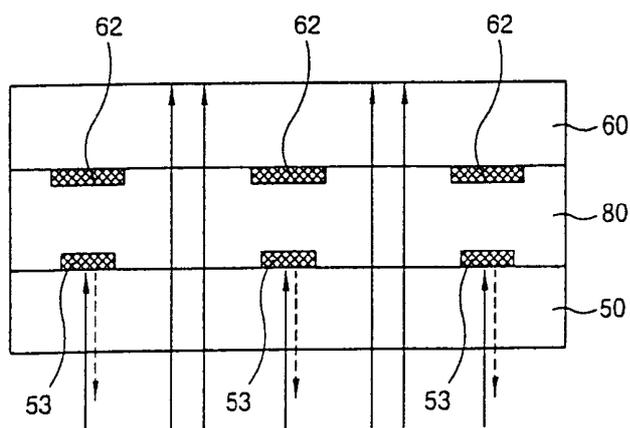


FIG. 4
CONVENTIONAL ART

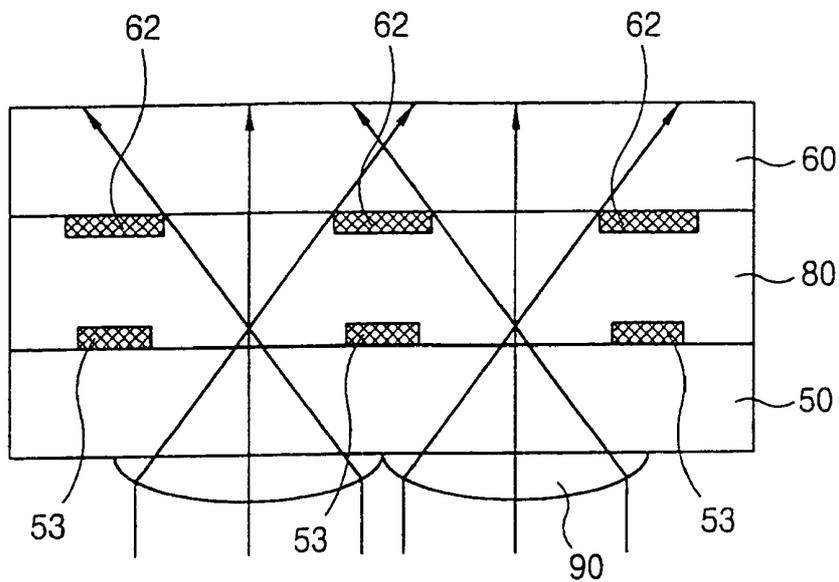


FIG. 5

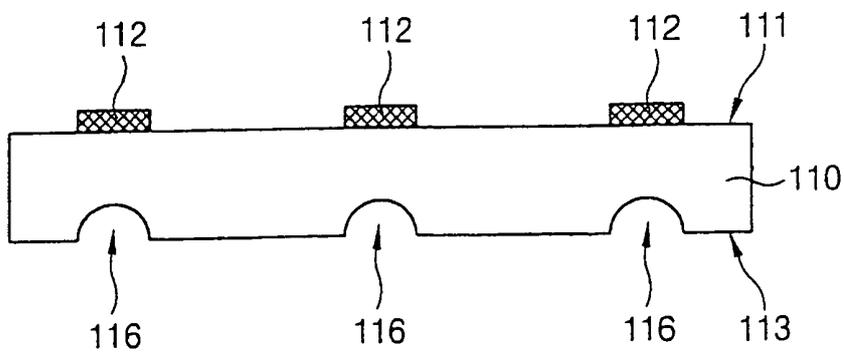


FIG. 6A

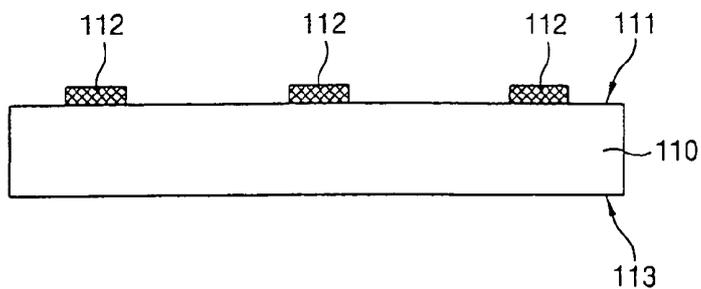


FIG. 6B

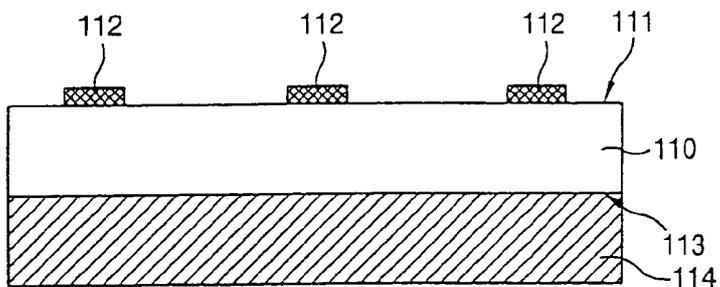


FIG. 6C

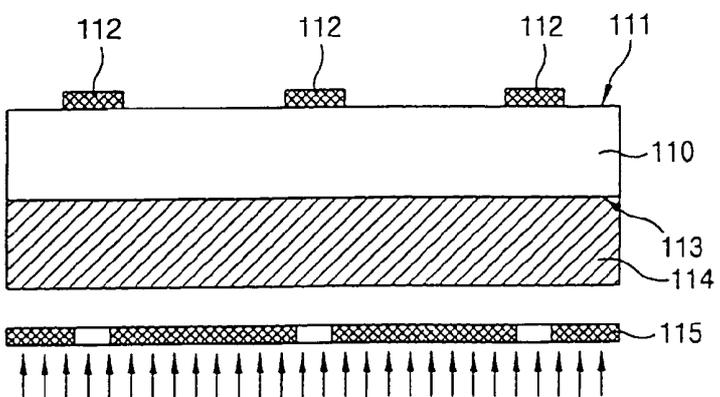


FIG. 6D

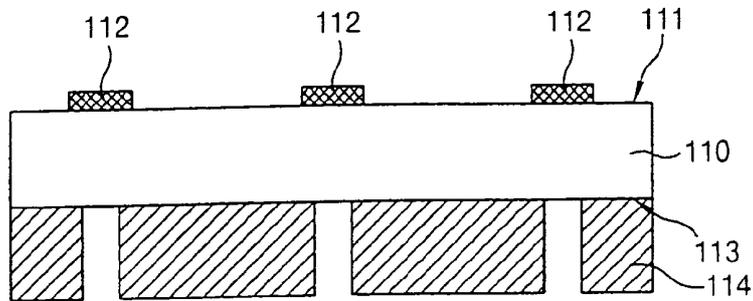


FIG. 6E

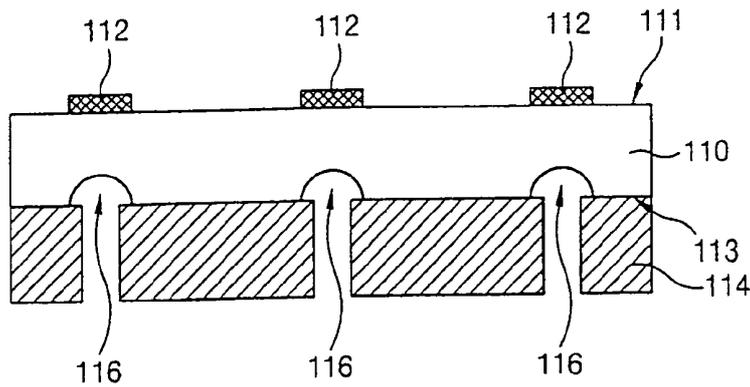


FIG. 6F

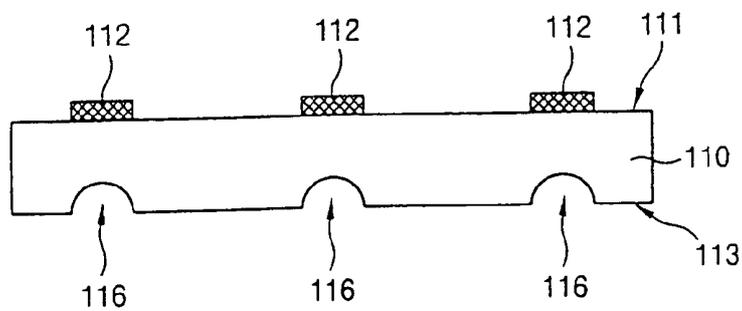


FIG. 7

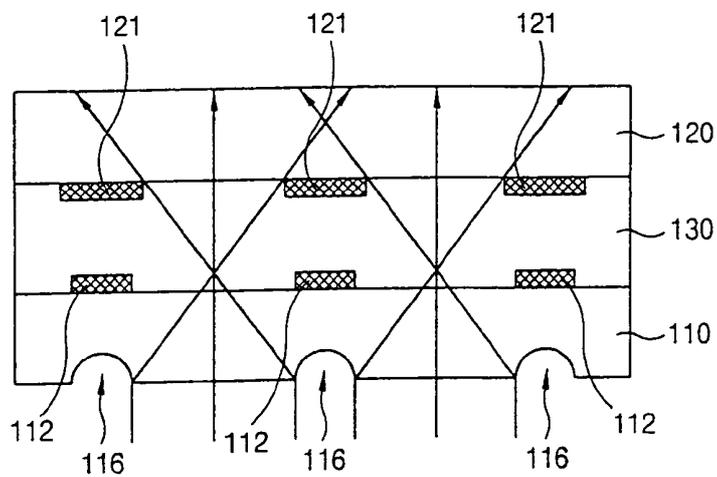


FIG. 8

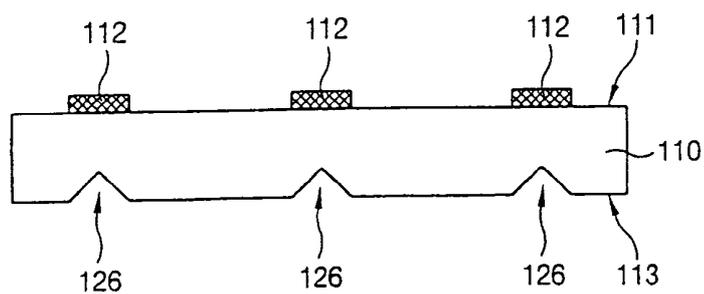


FIG. 9

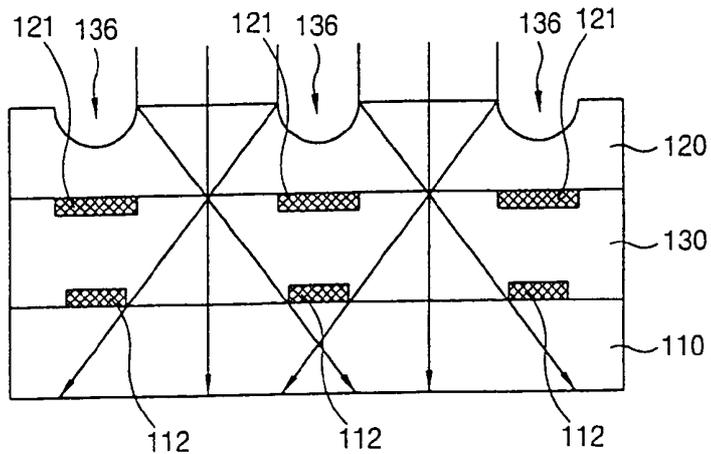


FIG. 10

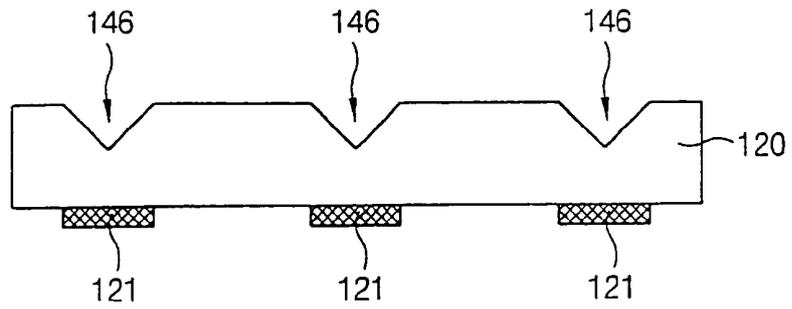


FIG. 11

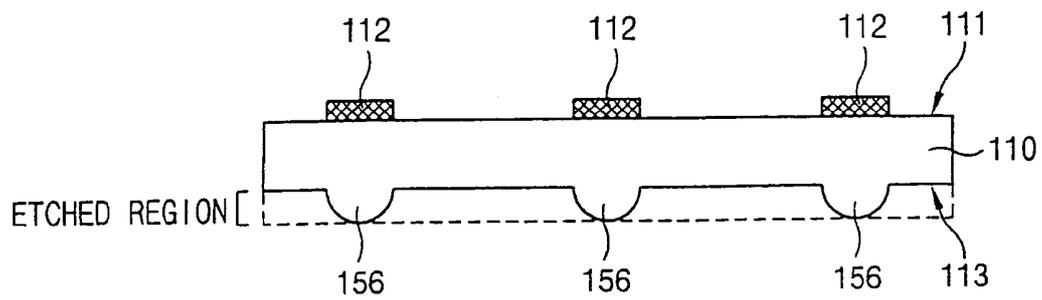


FIG. 12A

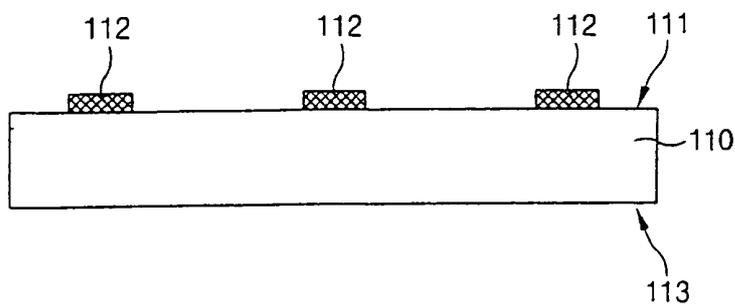


FIG. 12B

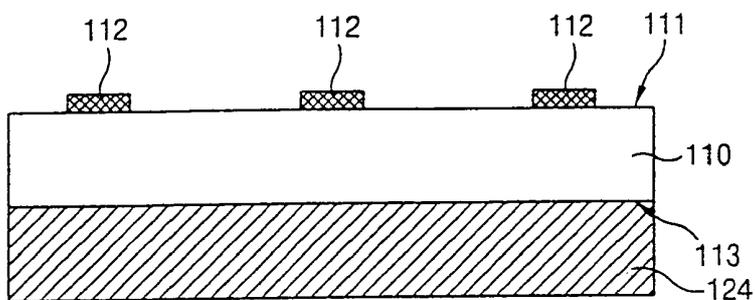


FIG. 12C

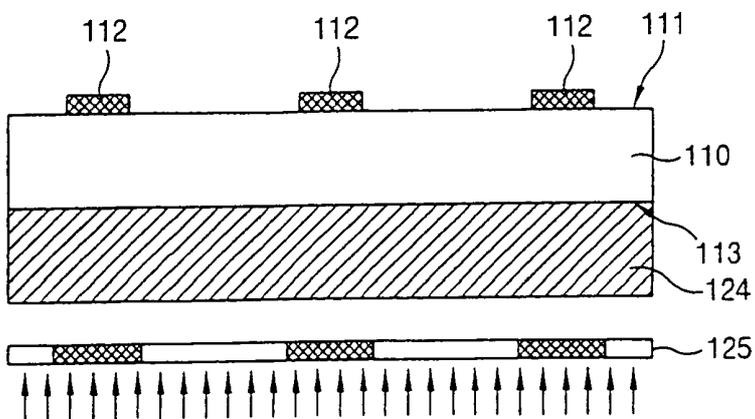


FIG. 12D

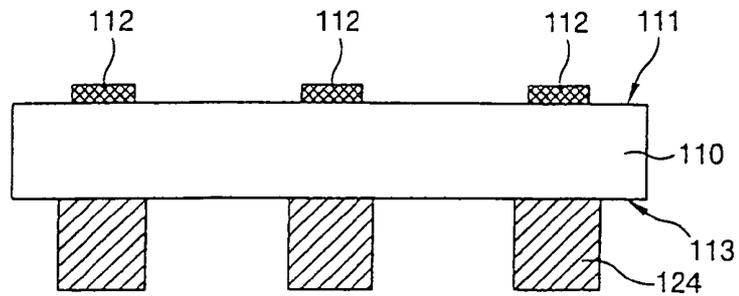


FIG. 12E

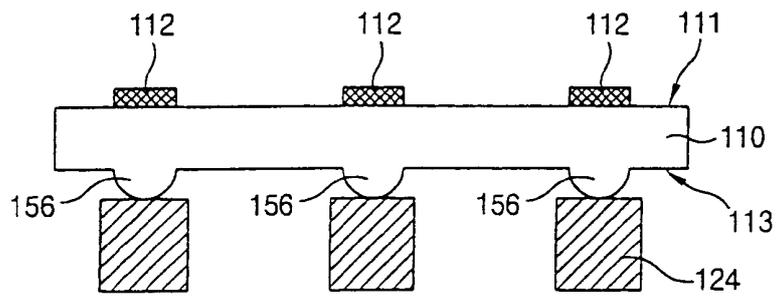


FIG. 12F

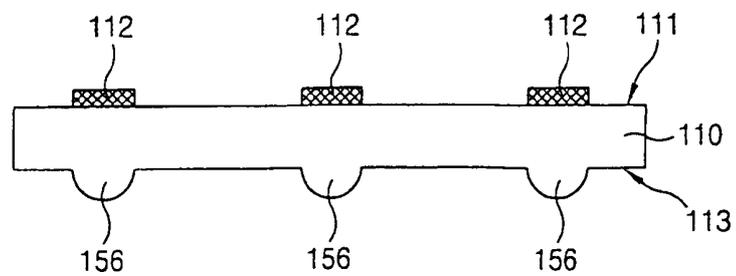


FIG. 13

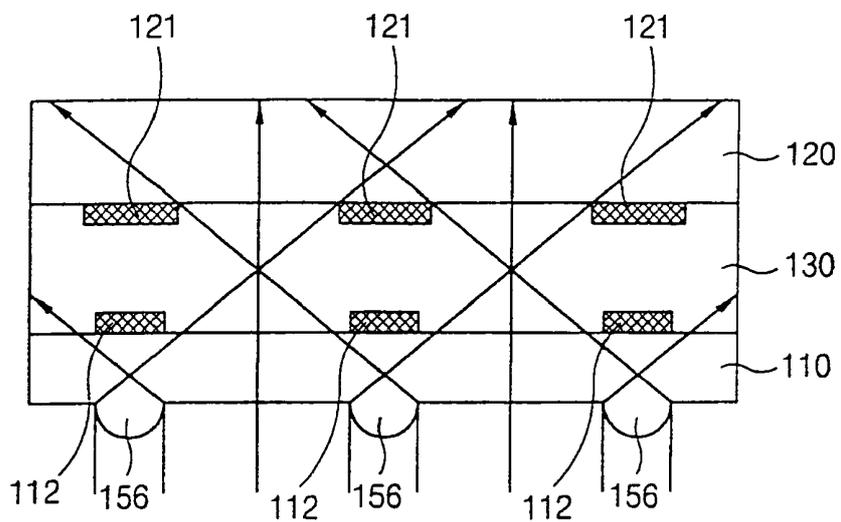


FIG. 14

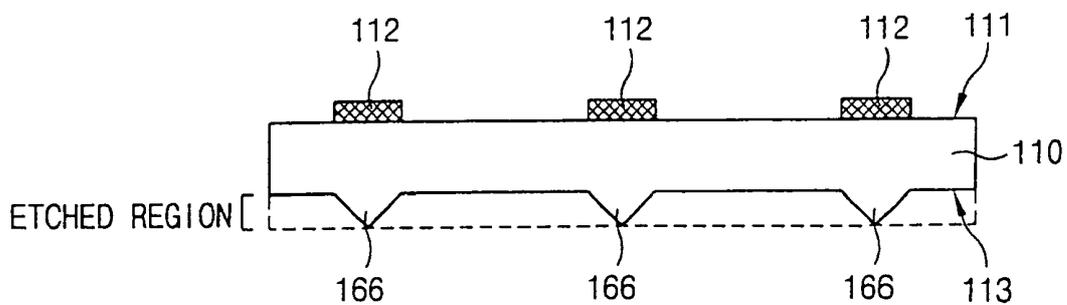


FIG. 15

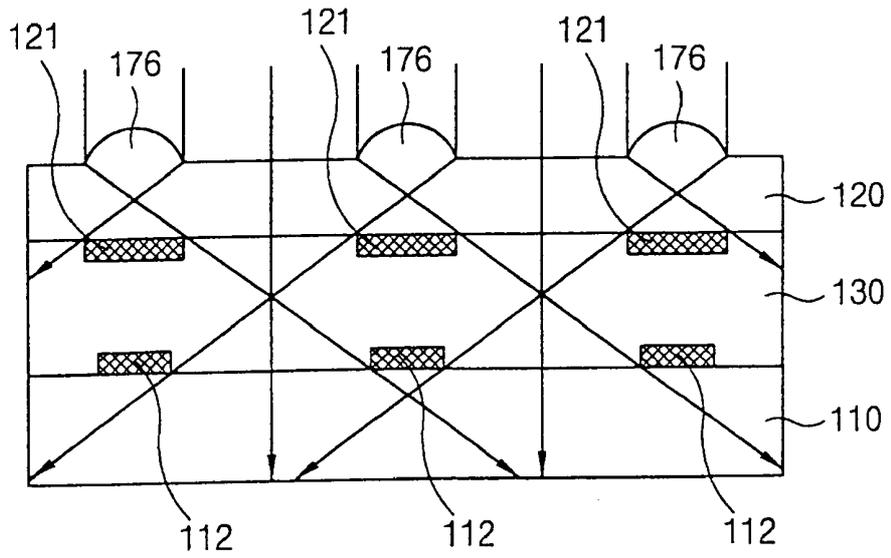
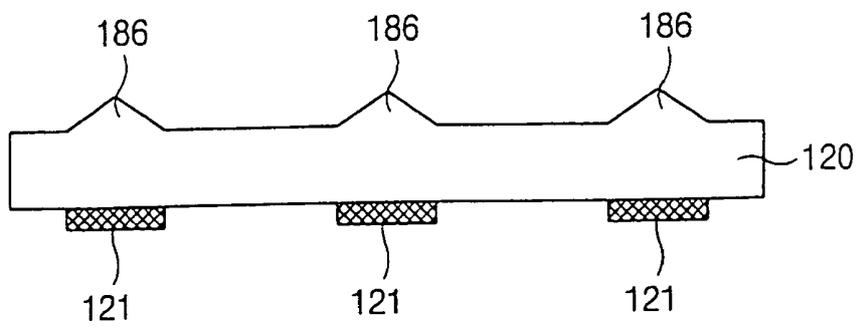


FIG. 16



SUBSTRATE STRUCTURE OF LIQUID CRYSTAL DISPLAY AND FABRICATION METHOD THEREOF

This application is a Divisional of application Ser. No. 10/260,437 filed Oct. 1, 2002 now U.S. Pat. No. 6,989,874, the entire contents of which are hereby incorporated by reference, and for which priority is claimed under 35 U.S.C. §120. The present application claims the benefit of Korean Patent Application No. 88578/2001 filed Dec. 29, 2001, under 35 U.S.C. §119, which is herein fully incorporated by reference.

BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention relates to a substrate structure of a liquid crystal display and a fabrication method thereof, and in particular to a substrate structure of a liquid crystal display and a fabrication method thereof that are capable of improving the light transmittance of the liquid crystal display.

2. Description of the Background Art

In general, liquid crystal display is for displaying pictures by adjusting the light transmittance of liquid crystal cells. Data signals according to picture information are supplied to the liquid crystal cells individually arranged in a matrix form.

The liquid crystal display includes a liquid crystal display panel having pixel unit liquid crystal cells in a matrix form and a driver IC (integrated circuit) for operating the liquid crystal cells. The liquid crystal display panel includes a color filter substrate and a TFT (thin film transistor) array substrate facing each other and a liquid crystal layer filled between them.

On the TFT array substrate of the liquid crystal display panel, parallel data lines for transmitting data signals from a data driver IC to the liquid crystal cells and parallel gate lines for transmitting scanning signals from a gate driver IC to the liquid crystal cells cross each other at about 90° angles. A liquid crystal cell is defined at each cross portion of the data line and the gate line.

The gate driver IC sequentially selects the liquid crystal cells arranged in matrix form by one line unit by applying scanning signals to the plural gate lines sequentially, and the selected one line of the liquid crystal cells receive data signals from the data driver IC.

In the meantime, the color filter substrate and the TFT array substrate facing each other include a common electrode and pixel electrodes in order to apply electric field to the liquid crystal layer. The pixel electrode is allocated to each liquid crystal cell formed on the TFT array substrate. On the other hand, the common electrode is formed onto the entire surface of the color filter substrate as one body. Accordingly, when a voltage is applied to the common electrode, by controlling a voltage applied to each of pixel electrodes, light transmittance of the liquid crystal cells can be individually controlled.

As described above, in order to control the voltage applied to the pixel electrode for each liquid crystal cell, a TFT used as a switching device is formed at each liquid crystal cell.

The construction parts of the liquid crystal display will be described in more detail with reference to accompanying drawings.

First, FIG. 1 is a plan view illustrating a unit pixel of a general liquid crystal display.

As depicted in FIG. 1, in the unit pixel of the general liquid crystal display, gate lines 4 are arranged in rows at regular intervals, and data lines 2 are arranged in columns at regular intervals. Accordingly, the gate lines 4 and the data lines 2 are

arranged in the matrix format. Herein, each unit liquid crystal cell is defined at each cross portion of the data line 2 and the gate line 4 and includes a TFT and a pixel electrode 14.

For each TFT, a gate electrode 10 is formed by being extended from a certain portion of the gate line 4, a source electrode 8 is extended from the data line 2, and accordingly the gate electrode 10 overlaps with a certain portion of the source electrode 8. A drain electrode 12 is formed at a portion corresponding to the source electrode 8 on the basis of the gate electrode 10. The pixel electrode 14 electrically contacts the drain electrode 12 through a drain contact hole 16 formed through the drain electrode 12.

The TFT also includes a semiconductor layer (not shown) for forming a conductive channel between the source electrode 8 and the drain electrode 12 as a scanning signal is applied to the gate electrode 10 through the gate line 4.

As described above, because the TFT forms the conductive channel between the source electrode 8 and the drain electrode 12 by receiving the scanning signal from the gate line 4, a data signal supplied to the source electrode 8 through the data line 2 is transmitted to the drain electrode 12 through this conductive channel.

The pixel electrode 14 in electric contact with the drain electrode 12 through the drain contact hole 16 is made of transparent ITO (indium tin oxide) having high light transmittance ratio. Herein, the pixel electrode 14 generates electric field at the liquid crystal layer with a common transparent electrode (not shown) formed on the color filter substrate by the data signal supplied from the drain electrode 12.

As described above, when the electric field is applied to the liquid crystal layer, liquid crystal is rotated by dielectric anisotropy and transmits light generated from a back light unit to the color filter substrate through the pixel electrode 14, and a quantity of the transmitted light is adjusted by a voltage value of the data signal. Generally, the back light unit includes a light source and reflector for supplying light to the liquid crystal panel for displaying pictures, images, etc.

A storage electrode 20 in electric contact with the pixel electrode 14 through a storage contact hole 22 forms a storage capacitor 18 by being deposited on the gate line 4. A gate insulating layer (not shown) deposited in the process of forming of the TFT is inserted between the storage electrode 20 and the gate line 4.

The storage capacitor 18 charges a voltage value of a data signal for a turn-on period of the TFT in which the scanning signal is applied to the gate lines 4, and supplies the charged voltage to the pixel electrode 14 for a turn-off period of the TFT. Accordingly, the operation of the liquid crystal is maintained.

FIG. 2 is an exemplary view illustrating a section of a unit pixel cut along line I-I' in FIG. 1. As shown in FIG. 2, the unit pixel includes a color filter substrate 60 and a TFT array substrate 50 facing each other; a spacer 70 for separating the TFT array substrate 50 and the color filter substrate 60 from each other; and a liquid crystal layer 80 filled into the space between the TFT array substrate 50 and the color filter substrate 60.

The fabrication process of the TFT of the liquid crystal display will be described in detail with reference to FIG. 2.

First, the gate electrode 10 is formed by depositing a metal such as Mo, Al or Cr on the TFT array substrate 50 using a sputtering method and by patterning it through a first mask. A gate insulating layer 30 is then formed by depositing an insulating substance such as SiNx, etc. on the TFT array substrate 50 having the gate electrode 10. An active layer 36 of the TFT is formed by sequentially depositing a semiconductor layer 32 made of amorphous silicon and an ohmic

contact layer **34** made of n+ amorphous silicon doped with impurities having high density on the gate insulating layer **30** and patterning them through a second mask.

The source electrode **8** and the drain electrode **12** of the TFT are then formed by depositing metal substance on the gate insulating layer **30** and the ohmic contact layer **34** and patterning it through a third mask. Herein, the patterning is performed so as to make the source electrode **8** and the drain electrode **12** separate from each other and face each other at the upper portion of the active layer **36**. Accordingly, the ohmic contact layer **34** on the upper portion of the active layer **36** is exposed, and the exposed ohmic contact layer **34** is removed in patterning of the source electrode **8** and the drain electrode **12**.

When the portion of the ohmic contact layer **34** is removed, a portion of the semiconductor layer **32** is exposed, and the exposed portion of the semiconductor layer **32** is defined as a channel region of the TFT.

A passivation film **38** made of SiNx is then deposited onto the gate insulating layer **30** on which the source electrode **8** and the drain electrode **12**, etc. are formed with the exposed semiconductor layer **32**. This can be done using a CVD (chemical vapor deposition) method. Herein, inorganic substance such as SiNx, etc. is used as a material of the passivation film **38**. Recently, in order to improve the aperture ratio of the liquid crystal cell, organic substances having low dielectric constant such as BCB (benzocyclobutene), SOG (spin on glass) or acryl, etc. are used.

A drain contact hole **16** for exposing a part of the drain electrode **12** is then formed by selectively etching the passivation film **38** formed on the drain electrode **12** through a fourth mask.

Thereafter, a pixel electrode **14** is formed by sputtering a transparent electrode substance onto the passivation film **38** and patterning it through a fifth mask. Afterward, patterning is performed so as to make the pixel electrode **14** in contact with the drain electrode **12** through the drain contact hole **16**.

Lastly, after forming an oriented film **51** on the TFT, a rubbing process is performed. A first polarizing plate **52** is also formed onto the TFT array substrate **50** opposite to the oriented film **51**. Accordingly, the fabrication of the TFT array substrate **50** having the TFT is finished. Herein, the rubbing process means rubbing the surface of the oriented film **51** with a fabric at a uniform pressure and speed so as to arrange polymer chain on the surface of the oriented film **51** in a certain direction in order to determine an early oriented direction.

The fabrication process of the storage capacitor region will now be described in detail with reference to accompanying FIG. 2.

First, the gate insulating layer **30** is formed after patterning the gate line **4** on the TFT array substrate **50**. The storage electrode **20** is then patterned on the gate insulating layer **30**. Herein, the storage electrode **20** is formed during the patterning of the source electrode **8** and the drain electrode **12** of the TFT. The storage electrode **20** overlaps with a part of the gate line **4** with the gate insulating layer **30** formed between them and is operated as the storage capacitor **18**.

The passivation film **38** is then formed on the gate insulating layer **30** on which the storage electrode **20** is formed, and the storage contact hole **22** for exposing a part of the storage electrode **20** is formed by etching a part of the passivation film **38**. Herein, the storage contact hole **22** is formed as the drain contact hole **16** of the TFT is formed.

The pixel electrode **14** is then patterned on the passivation film **38**, and the pixel electrode **14** is in contact with the storage electrode **20** through the storage contact hole **22**.

Herein, the pixel electrode **14** is formed in the patterning process of the pixel electrode **14** in the TFT region.

The fabrication process of the color filter substrate **60** having the color filter structure will now be described in detail with reference to FIG. 2.

First, a black matrix **62** is coated onto the color filter substrate **60** (e.g., glass substrate) at regular intervals. A red•green•blue color filter **63** is then formed onto the color filter substrate **60** on which the black matrix **62** is not coated. However, the color filter **63** is extended to certain regions of the black matrix **62**.

A common electrode **64** is then formed by forming a metal substance onto the entire upper surface of the color filter **63** including the black matrix **62** and by patterning it. An oriented film **65** is then formed on the entire upper surface of the obtained body, and rubbing is performed. A second polarizing plate **66** is also formed on the opposite surface of the obtained body (color filter substrate **60**) so as to correspond to the oriented film **65**. Accordingly, the fabrication of the color filter substrate **60** having the color filter structure is finished.

When the fabrication of the TFT array region and the color filter region is finished as discussed above, a sealant (not shown) is printed onto the TFT array substrate **50**, and the spacer **70** is dispersed on the color filter substrate **60**. Herein, according to circumstances, the spacer **70** is dispersed on the TFT array substrate **50**, and the sealant is printed onto the color filter substrate **60**.

Afterward, the TFT array substrate **50** and the color filter substrate **60** having the above-described structures are adhered to each other. The adhered TFT array substrate **50** and the color filter substrate **60** are then cut into unit liquid crystal display panels. Herein, because plural liquid crystal display panels are simultaneously formed onto a glass substrate having a large area to improve a yield rate, a cutting process is required.

A liquid crystal layer **80** is formed at a space between the oriented film **51** of the TFT array substrate **50** and the oriented film **65** of the color filter substrate **60** by injecting liquid crystal into the cut liquid crystal display panel through an injecting hole. Thereafter, the injecting hole is sealed. Herein, in an early liquid crystal display fabrication process, after injecting the liquid crystal into the plural liquid crystal display panels, the liquid crystal display panels are cut into unit liquid crystal display panels. However, if the size of the unit liquid crystal display panel increases, uniform liquid crystal injection become more intricate and productivity is lowered due to liquid crystal injection errors. To address this problem, a method which injects liquid crystal after cutting is preferred.

Because the unit liquid crystal display panel has minute cell-gap having a μm size in several hundred mm^2 area, in order to inject the liquid crystal efficiently, a vacuum injection method using a pressure difference between the inside and outside of the unit liquid crystal display panel is generally used.

The light transmittance process of the liquid crystal display panel fabricated by the above-described process will now be described in more detail with reference to accompanying FIGS. 1 and 2.

First, a common electrode voltage is supplied to the common electrode **64** formed on the surface of the color filter substrate **60** as one body. And a scanning signal is sequentially supplied from the gate driver IC (not shown) formed on the TFT transistor array substrate **50** to the gate line **4**. Accordingly, the liquid crystal cells arranged in the matrix form are sequentially selected by the gate line units.

The scanning signal supplied to the liquid crystal cells of the selected gate line **4** is applied to the gate electrode **10** of the TFT of each cell, and accordingly a conductive channel is formed between the source electrode **8** and the drain electrode **12**.

In the meantime, a data signal is supplied from the data driver IC (not shown) to the liquid crystal cell of the selected gate line **4** through the selected data line **2**, and the supplied data signal is applied to the source electrode **8** of the TFT. Accordingly, the data signal applied to the source electrode **8** of the TFT is supplied to the drain electrode **12** through the conductive channel for a scanning signal apply period. The data signal supplied to the drain electrode **12** of the TFT is supplied to the pixel electrode **14** in contact with the drain electrode **12** and operates the liquid crystal with the common electrode voltage supplied to the common electrode **64** of the color filter substrate **60**.

Because the pixel electrode **14** contacts the storage electrode **20** through the storage contact hole **22**, the data signal supplied to the pixel electrode **14** is supplied to the storage electrode **20** for the scanning signal apply period and is charged to the storage capacitor **18**. The voltage charged in the storage capacitor **18** is then supplied to the pixel electrode **14** for the TFT turn-off period in which the scanning signal is not applied, and accordingly the operation of the liquid crystal is maintained.

As described above, by applying the common electrode voltage to the common electrode **64** formed on the surface of the color filter substrate **60** as one body and applying the voltage of the data signal to the pixel electrode **14** of the liquid crystal cells on the TFT array substrate **50** selected by the gate line units, the electric field is applied to the liquid crystal layer **80** between the common electrode **64** and the pixel electrode **14**.

When the electric field is applied to the liquid crystal layer **80**, the liquid crystal is rotated by dielectric anisotropy and transmits the light generated by the back light unit from the TFT array substrate **50** to the color filter substrate **60** through the pixel electrode **14**, the liquid crystal layer **80** and the common electrode **64**. Herein, according to an amplitude of the voltage of the data signal applied to the pixel electrode **14**, strength/weakness of the electric field is adjusted, and the light transmittance of the liquid crystal layer **80** is adjusted by the strength /weakness of the electric field.

When the electric field in a certain direction is continually applied to the liquid crystal layer **80**, however, the liquid crystal is deteriorated. Accordingly, in order to prevent the deterioration of the liquid crystal, the data signal voltage value is repeated as positive/negative as it is applied to the common electrode voltage. This is called a reverse operating method.

As described above, the liquid crystal display displays pictures by adjusting light transmittance, and the picture quality is affected by the light transmittance. Thus, a product having a good light transmittance can display bright and clear pictures.

FIG. **3** is an exemplary view illustrating the light transmittance of a general liquid crystal display panel.

FIG. **3** illustrates the TFT array substrate **50** and the color filter substrate **60** facing to each other; the liquid crystal layer **80** filled between the TFT array substrate **50** and the color filter substrate **60**; and the wirings **53** and the black matrix **62** respectively patterned on the TFT array substrate **50** and the color filter substrate **60** so as to correspond to each other.

Accordingly, the light emitted from the back light unit (not shown) is transmitted through the pixel region of the liquid crystal display panel and displays a picture. However,

because the light emitted from the back light unit is reflected at the region on the TFT array substrate **50** in which the wirings **53** are formed, light transmittance of the liquid crystal display panel is lowered. Thus, in the conventional liquid crystal display panel, light transmittance is not good. In order to solve this problem, a liquid crystal display panel for improving the light transmittance has been presented.

FIG. **4** is an exemplary view illustrating the light transmittance of a the liquid crystal display panel having improved light transmittance. In comparison with the conventional liquid crystal display panel in FIG. **3**, it further includes a plurality of micro lenses **90** corresponding to gaps between the wirings.

The micro lens **90** is fabricated as a unit pixel shape, is aligned with gaps between the wirings **53** and is adhered to the TFT array substrate **50** so as not to face the color filter substrate **60**. In more detail, the micro lenses **90** are adhered to the surface not having the wirings **53** and facing the back light unit.

The micro lens **90** refracts the light transmitted from the back light unit to the TFT array substrate **50** toward the pixel region of the liquid crystal display panel in order to improve a flux of light being transmitted through the pixel region of the liquid crystal display panel. However, in the fabrication of such a liquid crystal display panel including the micro lenses **90** between the wirings **53**, by additionally fabricating the micro lenses **90** in a unit pixel shape, aligning each micro lens **90** and adhering it with the unit pixel of the liquid crystal display panel, the productivity of the liquid crystal display panel may be lowered, and accordingly a production cost may be increased.

In addition, because the micro lens **90** adhered to each unit pixel of the liquid crystal display panel increases the weight and thickness of the liquid crystal display panel, it is difficult to lower the weight of the liquid crystal display and slim down the liquid crystal display.

Further, because the light generated by the back light unit is transmitted through the micro lenses **90** in the pixel region of the liquid crystal display panel, a refractive index difference arises due to the different materials of the TFT array substrate **50** and the micro lenses **90**, and as a result, light reflecting elements are generated. Accordingly, the light transmittance of the liquid crystal display is not remarkably improved in comparison with improvement of light usage efficiency.

SUMMARY OF THE INVENTION

In order to solve the above-mentioned problems and other problems, it is an object of the present invention to provide a substrate structure of a liquid crystal display and a fabrication method thereof that are capable of improving the light transmittance efficiency of a liquid crystal display panel.

It is another object of the present invention to provide a substrate structure of a liquid crystal display and a fabrication method thereof that are capable of not only reducing the weight of the light crystal panel and slimming down the liquid crystal display panel but also improving the light transmittance efficiency thereof.

In order to achieve the above-mentioned objects, a substrate structure of a liquid crystal display in accordance with an embodiment of the present invention includes a first substrate and a second substrate having a liquid crystal layer therebetween, at least one of a wiring and a black matrix formed on an internal surface of at least one of the first and second substrates, and at least one light refracting member formed on at least one of outer surfaces of the first and second

substrates not facing the other substrate so as to correspond to the wiring or the black matrix.

A substrate structure usable in a display device according to an embodiment of the present invention includes a substrate including first and second surfaces, a light blocking member disposed on the second surface of the first substrate, and a light refracting member integrally disposed at the first surface of the substrate and being aligned with the light blocking member, such that light impinging on the first surface of the substrate from a light source is refracted through the first substrate away from the light blocking member.

A method for fabricating a substrate of a liquid crystal display according to an embodiment of the present invention includes forming first and second substrates having a liquid crystal layer therebetween, the first substrate having a wiring patterned thereon, the second substrate having a black matrix patterned thereon, and forming at least one light refracting member on at least one of outer surfaces of the first and second substrates not facing the other substrate so as to correspond to the wiring or the black matrix.

A method for fabricating a substrate of a liquid crystal display according to an embodiment of the present invention includes forming a light blocking member on a first surface of a substrate, forming a pattern of a photosensitive film that selectively exposes portions of a second surface of the substrate corresponding to the light blocking member, forming cylindrical grooves or wedge-shaped grooves by selectively removing the exposed portions of the second surface of the substrate through the pattern of the photosensitive film, and removing the pattern of the photosensitive film.

A method for fabricating a substrate of a liquid crystal display according to an embodiment of the present invention includes forming a light blocking member on a first surface of a substrate, forming a pattern of a photosensitive film that selectively masks portions of a second surface of the substrate corresponding to the light blocking member, forming cylindrical protrusions or wedge-shaped protrusions by selectively removing the second surface of the substrate using the pattern of the photosensitive film, and removing the pattern of the photosensitive film.

A method for fabricating a substrate usable in a display device according to an embodiment of the present invention includes providing a substrate including first and second surfaces, forming a light blocking member on the second surface of the substrate, and forming a light refracting member integrally at the first surface of the substrate and being aligned with the light blocking member, such that light impinging on the first surface of the substrate from a light source is refracted through the first surface away from the light blocking member.

These and other objects of the present application will become more readily apparent from the detailed description given hereinafter. However, it should be understood that the detailed description and specific examples, while indicating preferred embodiments of the invention, are given by way of illustration only, since various changes and modifications within the spirit and scope of the invention will become apparent to those skilled in the art from this detailed description.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this specification, illustrate embodiments of the invention and together with the description serve to explain the principles of the invention.

In the drawings:

FIG. 1 is a plan view illustrating a unit pixel of a general liquid crystal display;

FIG. 2 is an exemplary view illustrating a section of the unit pixel cut along line I-I' in FIG. 1;

FIG. 3 is an exemplary view illustrating light transmission of a general liquid crystal display panel;

FIG. 4 is an exemplary view illustrating light transmission of a liquid crystal display panel having improved light transmittance;

FIG. 5 is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a first embodiment of the present invention;

FIGS. 6A to 6F are exemplary views sequentially illustrating fabrication processes of the substrate structure of the liquid crystal display in accordance with the first embodiment of the present invention;

FIG. 7 is an exemplary view illustrating light transmission of the liquid crystal display panel using the substrate structure of FIG. 5 in accordance with the first embodiment of the present invention;

FIG. 8 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the first embodiment of the present invention;

FIG. 9 is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a second embodiment of the present invention;

FIG. 10 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the second embodiment of the present invention;

FIG. 11 is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a third embodiment of the present invention;

FIGS. 12A to 12F are exemplary views sequentially illustrating fabrication processes of the substrate structure of the liquid crystal display in accordance with the third embodiment of the present invention;

FIG. 13 is an exemplary view illustrating light transmission of the liquid crystal display panel using the substrate structure of FIG. 11 in accordance with the third embodiment of the present invention;

FIG. 14 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the third embodiment of the present invention;

FIG. 15 is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a fourth embodiment of the present invention; and

FIG. 16 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the fourth embodiment of the present invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The preferred embodiments of the present invention will be described in detail with reference to accompanying drawings.

FIG. 5 is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a first embodiment of the present invention.

As depicted in FIG. 5, the substrate structure includes a substrate 110 having a flat first surface 111, a second surface 113, a light transmission region and a light cut-off region; wirings 112 patterned on the light cut-off region of the first surface 111 of the substrate 110; and cylindrical grooves 116 formed on the second surface 113 of the substrate 110 along the length direction of the wiring 112.

FIGS. 6A to 6F are exemplary views sequentially illustrating fabrication processes of the substrate structure of the liquid crystal display in accordance with the first embodiment of the present invention.

First, as depicted in FIG. 6A, the wirings 112 are patterned on the first surface 111 of the substrate 110. In this example, the substrate 110 is a TFT array substrate of a liquid crystal display, and the first surface 111 on which the wiring 112 is patterned faces a color filter substrate of the liquid crystal display.

Accordingly, with reference to FIG. 1, the wirings 112 patterned on the first surface 111 of the substrate 110 can be gate lines and/or data lines crossing each other. Unit pixels each having the TFT at each cross portion of the gate lines and the data lines are defined on the first surface 111 of the substrate 110.

As depicted in FIG. 6B, a resist film 114 made of a photo-sensitive resin material is then coated onto the second surface 113 of the substrate 110. Herein, the second surface 113 of the substrate 110 does not face the color filter substrate of the liquid crystal display but faces a back light unit.

As depicted in FIG. 6C, an exposure process is then selectively performed on the resist film 114 through a mask 115 on which a light transmission region and a light cut-off region are patterned. Herein, by appropriately patterning the light transmission region and the light cut-off region, the exposure region of the resist film 114 is arranged along the wirings 112 patterned on the first surface 111 of the substrate 110. It is preferable for the exposure region to have a width narrower than the wirings 112.

In FIG. 6C, if a positive type resist film 114 is used in which a light irradiated region is eliminated by developing, the exposure process is performed through the mask 115 on which the light transmission region and the light cut-off region are appropriately patterned. However, if a negative type resist film 114 is used in which a light irradiated region remains by developing, the exposure process is performed through the mask 115 on which the light transmission region and the light cut-off region are conversely patterned.

As depicted in FIG. 6D, by developing the resist film 114, the pattern of the resist film 114 which selectively exposes the second surface 113 of the substrate 110 is formed. Herein, the regions of the second surface 113 of the substrate 110 selectively exposed by the pattern of the resist film 114 are aligned with the wirings 112 patterned on the first surface 111. In one embodiment, each exposed region has a width narrower than that of the corresponding wiring 112.

As depicted in FIG. 6E, by etching the exposed regions of the second surface 113, cylindrical grooves 116 are then formed so as to align with the wirings 112 patterned on the first surface 111. Herein, in order to perform an undercut etching of the lower portion of the resist film 114 at not only the exposed regions of the second surface 113 but also their surrounding around regions, a wet-etching is applied. And, it is preferable to adjust the etching condition appropriately. In one embodiment, the cylindrical grooves 116 formed at the second surface 113 of the substrate 110 have the same width as the wirings 112 patterned on the first surface 111 of the substrate 110.

As depicted in FIG. 6F, the pattern of the remaining resist film 114 is then removed and the substrate 110 with the cylindrical grooves 116 is formed.

FIG. 7 is an exemplary view illustrating light transmission of the liquid crystal display panel using the substrate structure of FIG. 5 in accordance with the first embodiment of the present invention.

As depicted in FIG. 7, the substrate structure in accordance with the first embodiment of the present invention includes a first substrate 110 and a second substrate 120 adhered to each other so as to face each other and have a certain space between them; a liquid crystal layer 130 filled into the space between the first substrate 110 and the second substrate 120; wirings 112 and a black matrix 121 respectively patterned on each internal surface of the first substrate 110 and the second substrate 120 so as to face each other; and cylindrical grooves 116 formed at the outer surface or a surface on which the wirings 112 of the first substrate 110 are not formed, along the length direction of the wirings 112.

In this embodiment, the first and second substrates 110, 120 respectively represent the TFT array substrate and the color filter substrate facing and adhered to each other. The cylindrical grooves 116 are formed on the surface not facing the second substrate 120 of the first substrate 110 (namely, the surface facing the back light unit on which the wirings 112 are not formed) and extend along the length direction of the wirings 112 patterned on the surface facing the second substrate 120 of the first substrate 110 so that the cylindrical grooves 116 and the wirings 112 are aligned with each other. Accordingly, the cylindrical grooves 116 improve the flux of light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the wirings 112 toward the pixel region of the liquid crystal display panel. Thus, the cylindrical grooves 116 function as light refracting members.

Furthermore, in the pixel region of the liquid crystal display panel, the cylindrical grooves 116 are defined at the substrate 110 itself and are integrated part of the substrate 110. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the cylindrical grooves 116 are formed at the surface not facing the second substrate 120 of the first substrate 110 (namely, the surface facing the back light unit on which the wirings 112 are not formed) by using the etching or other similar process. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

FIG. 8 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the first embodiment of the present invention.

As depicted in FIG. 8, in comparison with FIG. 5, in substitute for the cylindrical grooves 116 formed on the second surface 113 of the substrate 110 along the length direction of the wirings 112, wedge-shaped grooves 126 are formed to extend along the length direction of the wirings 112 in alignment with the wirings 112.

The wedge-shaped grooves 126 can be formed by applying a dry-etching in the etching process in FIG. 6E and adjusting the etching condition as needed to obtain the wedge shape. The selection and use of a specific etching condition will vary depending on the desired dimensions of the wedge-shaped grooves 126, which is a technique appreciated by one skilled in the art. Similar to the cylindrical grooves 116, the wedge-shaped grooves 126 improve the flux of the light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the wirings 112 patterned on the first substrate 110 toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the wedge-shaped grooves **126** are defined at the substrate **110** itself and are integrated part of the substrate **110**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the wedge-shaped grooves **126** are formed by etching the second surface **113** of the substrate **110**. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

FIG. **9** is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a second embodiment of the present invention.

As depicted in FIG. **9**, the substrate structure of the liquid crystal display in accordance with the second embodiment of the present invention includes a first substrate **110** and a second substrate **120** adhered to each other so as to face each other and having a certain space between them; a liquid crystal layer **130** filled into the space between the first substrate **110** and the second substrate **120**; wirings **112** and a black matrix **121** respectively patterned on each internal surface of the first substrate **110** and the second substrate **120** so as to face each other; and cylindrical grooves **136** formed at the outer surface of the second substrate **120** on which the black matrix **121** is not formed so as to correspond to the black matrix **121**.

In the substrate structure in FIG. **9**, in comparison with the substrate structure of FIG. **7**, the light from a light source such as the back light unit or ambient light impinges on the second substrate **120** first and then the first substrate **110**. More specifically, the light emitted from the back light unit is sequentially transmitted through the second substrate **120**, the liquid crystal layer **130** and the first substrate **110**. In one embodiment, the width of the black matrix **121** formed on the second substrate **120** is wider than that of the wirings **112** patterned on the first substrate **110** in order to prevent the light reflected at the black matrix **121** from being transmitted to the wirings **112** when the light is incident, as depicted in FIG. **9**.

Amorphous silicon formable at low temperature is generally used for the channel region of the TFT. However, when light is incident onto the amorphous silicon, leakage current is generated, and accordingly electric characteristics of the TFT may be changed. In order to prevent the change of the electric characteristics of the TFT, as depicted in FIG. **9**, light is sequentially transmitted through the second substrate **120**, the liquid crystal layer **130** and the first substrate **110**.

Accordingly, in the second embodiment of the present invention, the cylindrical grooves **136** are formed at the surface of the second substrate **120** on which the black matrix **121** is not formed. The fabrication processes are the same as the fabrication processes depicted in FIGS. **6A** to **6F**, except for forming the cylindrical grooves **136** not on the first substrate **110** but on the second substrate **120**.

The cylindrical grooves **136** formed at the surface of the second substrate **120** on which the black matrix **121** is not formed improve the flux of the light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the black matrix **121** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the cylindrical grooves **136** are defined at the

second substrate **120** itself and are integrated part of the second substrate **120**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the cylindrical grooves **136** are formed by etching the surface facing the back light unit on which the black matrix **121** is not formed. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

FIG. **10** is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the second embodiment of the present invention.

As depicted in FIG. **10**, in comparison with FIG. **9**, in substitute for the cylindrical grooves **136** formed on the surface of the second substrate **120** facing the back light unit, wedge-shaped grooves **146** are formed to correspond with the black matrix **121**.

The wedge-shaped grooves **146** can be formed by applying the dry-etching or other suitable process in the etching process for forming the cylindrical grooves **136** in FIG. **9** and adjusting the etching condition appropriately, as same as the process of forming the cylindrical grooves **136** in FIG. **9**. The wedge-shaped grooves **146** improve the flux of the light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the black matrix **121** patterned on the second substrate **120** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the wedge-shaped grooves **146** are defined at the second substrate **120** itself and are integrated part of the second substrate **120**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the wedge-shaped grooves **146** are formed by etching the surface of the second substrate **120** on which the black matrix **121** is not formed. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

FIG. **11** is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a third embodiment of the present invention.

As depicted in FIG. **11**, the substrate structure of the liquid crystal display in accordance with the third embodiment of the present invention includes a substrate **110** having a flat first surface **111**, a second surface **113**, a light transmission region and a light cut-off region; wirings **112** patterned on the light cut-off region of the first surface **111** of the substrate **110**; and cylindrical protrusions **156** formed on the second surface **113** of the substrate **110** and extending along the length direction of the wirings **112**.

FIGS. **12A** to **12F** are exemplary views sequentially illustrating fabrication processes of the substrate structure of FIG. **11** in accordance with the third embodiment of the present invention.

First, as depicted in FIG. **12A**, the wirings **112** are patterned on the first surface **111** of the substrate **110**. In this

example, the substrate **110** is a TFT array substrate of the liquid crystal display, and the first surface **111** on which the wirings **112** are patterned faces a color filter substrate of the liquid crystal display.

Accordingly, with reference to FIG. 1, the wirings **112** patterned on the first surface **111** of the substrate **110** are the gate lines and the data lines crossing each other. The unit pixels having the TFT at each cross portion of the gate lines and the data lines are defined on the first surface **111** of the substrate **110**.

As depicted in FIG. 12B, a resist film **124** made of a photosensitive resin material is then coated onto the second surface **113** of the substrate **110**. Herein, the second surface **113** of the substrate **110** does not face the color filter substrate of the liquid crystal display but faces the back light unit.

As depicted in FIG. 12C, an exposure process is selectively performed onto the resist film **124** through a mask **125** on which a light transmission region and a light cut-off region are patterned. Herein, by appropriately patterning the light transmission region and the light cut-off region on the mask **125**, the exposure region of the resist film **124** extends along the wirings **112** patterned on the first surface **111** of the substrate **110**. In one embodiment, it is preferable for the exposure region to have a width greater than that of the wirings **112**.

In FIG. 12C, if a positive type resist film **124** is used in which a light irradiated region is eliminated by development, an exposure process is performed through the mask **125** on which the light transmission region and the light cut-off region are appropriately patterned. However, if a negative type resist film **124** is used in which a light irradiated region remains by development, the exposure process is performed through the mask **125** on which the light transmission region and the light cut-off region are conversely patterned.

As depicted in FIG. 12D, by developing the resist film **124**, the pattern of the resist film **124** which selectively exposes the second surface **113** of the substrate **110** is formed. The pattern of the remaining resist film **124** corresponds to the wirings **112**. Herein, the regions of the second surface **113** of the substrate **110** selectively exposed by the pattern of the resist film **124** are arranged to correspond with regions around the wirings **112** patterned on the first surface **111**. In one embodiment, the exposed regions have a width greater than that of the wirings **112**.

As depicted in FIG. 12E, by etching the exposed regions of the second surface **113** by using the pattern of the resist film **124**, the cylindrical protrusions **156** are formed so as to align with the wirings **112** patterned on the first surface **111**. Herein, in order to perform an undercut etching of the lower portion of the resist film **124** at not only the exposed regions of the second surface **113** but also their surrounding regions, it is preferable to adjust the etching conditions appropriately. Accordingly, the cylindrical protrusions **156** formed at the second surface **113** of the substrate **110** have the same width as the wirings **112** patterned on the first surface **111** of the substrate **110**.

As depicted in FIG. 12F, the pattern of the remained resist film **124** is then eliminated and the substrate **110** with the cylindrical protrusions **156** is formed.

FIG. 13 is an exemplary view illustrating light transmission of the liquid crystal display panel using the substrate structure of FIG. 11 in accordance with the third embodiment of the present invention.

As depicted in FIG. 13, another substrate structure of the liquid crystal display in accordance with the third embodiment of the present invention includes a substrate **110** having a flat first surface **111**, a second surface **113**, a light transmission region and a light cut-off region; wirings **112** and a black

matrix **121** respectively patterned on each internal surface of the first substrate **110** and the second substrate **120** so as to face each other; and cylindrical protrusions **156** formed on the outer surface of the first surface **110** on which the wirings **112** are not formed.

In this example, the first and second substrates **110**, **120** respectively represent the TFT array substrate and the color filter substrate facing and adhered to each other in a liquid crystal display panel.

The cylindrical protrusions **156** are formed on the surface of the first substrate **110** not facing the second substrate **120** (namely, the surface facing the back light unit) and extend along the length direction of the wirings **112** patterned on the surface of the first substrate **110** facing the second substrate **120**.

Accordingly, the cylindrical protrusions **156** can improve the flux of light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the wirings **112** patterned on the first substrate **110** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the cylindrical grooves **156** are defined at the substrate **110** itself and are integrated part of the substrate **110**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the cylindrical protrusions **156** are formed at the surface of the first substrate **110** not facing the second substrate **120** (namely, the surface facing the back light unit on which the wirings **112** are not formed) by the etching or similar process. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

Particularly, in the third embodiment of the present invention, by selectively removing portions of the substrate **110** around the cylindrical protrusions **156** and maintaining the cylindrical protrusions **156**, the weight of the liquid crystal display panel can be further reduced in comparison with the first and second embodiments of the present invention.

That is, in the first and second embodiments of the present invention, by forming grooves by etching a selected region from the surface of a substrate, the etched region is not large. However, in the third embodiment of the present invention, by forming protrusions by keeping only selected regions while generally etching out the surface of the substrate, the liquid crystal display panel's weight can be remarkably reduced.

FIG. 14 is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the third embodiment of the present invention.

As depicted in FIG. 14, in comparison with FIG. 11, in substitute for the cylindrical protrusions **156** formed on the second surface **113** of the substrate **110** along the length direction of the wiring **112**, wedge-shaped protrusions **166** are formed to extend along the length direction of the wirings **112**.

The wedge-shaped protrusions **166** can be formed by adjusting the etching condition in the etching process in FIG. 12E appropriately, as same as the cylindrical protrusions **156** in FIG. 13. The wedge-shaped protrusions **166** improve the flux of the light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident

from the back light unit onto the wiring **112** patterned on the first substrate **110** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the wedge-shaped protrusions **166** are defined at the first substrate **110** itself and are integrated part of the first substrate **110**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the wedge-shaped protrusions **166** are formed by etching the second surface **113** of the first substrate **110**. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

Particularly, similar to the formation of the cylindrical protrusions **156** in FIG. **13**, the wedge-shaped protrusions **166** are formed by removing the portions of the substrate **110** around the wedge-shaped protrusions **166** and maintaining the wedge-shaped protrusions **166**. In comparison with the first and second embodiments of the present invention, then the weight of the liquid crystal display panel can be further reduced.

FIG. **15** is an exemplary view illustrating a substrate structure of a liquid crystal display in accordance with a fourth embodiment of the present invention.

As depicted in FIG. **15**, the substrate structure of the liquid crystal display in accordance with the fourth embodiment of the present invention includes a substrate **110** having two flat first surfaces, a light transmission region and a light cut-off region; wirings **112** and the black matrix **121** respectively patterned on the internal surface of the first substrate **110** and the second substrate **120** so as to face each other; and cylindrical protrusions **176** formed on the outer surface of the second substrate **120** on which the black matrix **121** is not formed. The cylindrical protrusions **176** extend along the black matrix **121**.

In the substrate structure of the liquid crystal display in FIG. **15**, in comparison with FIG. **13**, light emitted from the back light unit impinges on the second substrate **120** first and then sequentially transmitted through the liquid crystal layer **130** and the first substrate **110** as in FIG. **9**. Since this is already described in detail with reference to FIG. **9**, the explanation will be abridged.

In the fourth embodiment of the present invention, the cylindrical protrusions **176** are formed at the surface of the second substrate **120** on which the black matrix **121** is not formed. The fabrication process of the cylindrical protrusions **176** on the second substrate **120** is the same as the fabrication process of the cylindrical protrusions **156** as illustrated in FIGS. **12A** to **12F**, except for forming the cylindrical protrusions **176** not on the first substrate **110** but on the second substrate **120**.

The cylindrical protrusions **176** formed on the second substrate **120** on which the black matrix **121** is not formed improve the flux of light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the black matrix **121** patterned on the second substrate **120** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the cylindrical protrusions **176** are defined at the second substrate **120** itself and are integrated part of the second substrate **120**. Thus, unlike the conventional art, it is

possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the cylindrical protrusions **176** are formed at the surface of the second substrate **120** not facing the first substrate **110** (namely, the surface facing the back light unit on which the black matrix **121** is not formed) by the etching or other suitable process. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

Particularly, in the fourth embodiment of the present invention, in the same manner as the cylindrical protrusions **156** and the wedge-shaped protrusions **166** formed on the first substrate **110** in accordance with the third embodiment of the present invention, by selectively remaining the cylindrical protrusions **176** while generally etching away the portions of the substrate **120** around the protrusions **176**, the weight of the liquid crystal display panel can be further reduced in comparison with the first and second embodiments of the present invention.

FIG. **16** is an exemplary view illustrating another substrate structure of a liquid crystal display in accordance with the fourth embodiment of the present invention.

As depicted in FIG. **16**, in comparison with FIG. **15**, in substitute for the cylindrical protrusions **176** formed on the surface of the second substrate **120** on which the black matrix **121** is not formed, wedge-shaped protrusions **186** are formed on the second substrate **120** to correspond with the black matrix **121**.

The wedge-shaped protrusions **186** can be formed by adjusting the etching condition in the etching process in FIG. **15** appropriately, as same as the cylindrical protrusions **176** in FIG. **15**. The wedge-shaped protrusions **186**, improve the flux of the light being transmitted through the pixel region of the liquid crystal display panel by refracting the light incident from the back light unit onto the black matrix **121** patterned on the second substrate **120** toward the pixel region of the liquid crystal display panel.

Furthermore, in the pixel region of the liquid crystal display panel, the wedge-shaped protrusions **186** are defined at the second substrate **120** itself and are integrated part of the second substrate **120**. Thus, unlike the conventional art, it is possible to prevent generation of reflecting elements due to a refractive index difference between the materials of the micro lenses and the substrate in the conventional device. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the wedge-shaped protrusions **186** are formed by etching the surface of the second substrate **120** on which the black matrix **121** is not formed. In comparison with the conventional device including the micro lenses, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

Particularly, in the same manner as the cylindrical protrusions **176** in FIG. **15**, in the wedge-shaped protrusions **186** shown in FIG. **16**, by selectively remaining the wedge-shaped protrusions **186** while generally etching out the portions of the second substrate **120** around the protrusions **186**, the weight of the liquid crystal display panel can further be reduced compared to the first and second embodiments of the present invention.

In the embodiments of the present invention, light refracting means (e.g., the cylindrical or wedge-shaped grooves or protrusions) aligned with the wirings or black matrix on the substrate can be fabricated as below.

In one method, by considering in advance the position at which the wiring or the black matrix is to be formed on the substrate, the light refracting means of the present invention can be formed first. Afterward, the wiring or the black matrix can be formed.

In another method, after forming the wiring or the black matrix on the substrate, the light refracting means can be formed so as to align with the wiring or the black matrix.

In still another method, after adhering the first substrate having the wirings to the second substrate having the black matrix, the light refracting means of the present invention can be formed on the outer surface of the first substrate or the second substrate so as to correspond to the wirings or the black matrix.

In the cylindrical grooves and the cylindrical protrusions in accordance with the embodiments of the present invention, the more the depth/length of the grooves/protrusions increases from the surface of the substrate, the more the quantity of light refracted to the picture region of the liquid crystal display panel is increased.

In more detail, the cylindrical grooves and the cylindrical protrusions are assumed as semicircular lenses. A radius of the lenses corresponds to one-half of the line width (L), and a gain variation quantity of actual light (ΔP_g) can be calculated according to the following Equation 1.

$$\Delta P_g = \frac{\left(3.14 \times \frac{L}{2}\right) - L}{L} = 0.57 \quad \text{[Equation 1]}$$

Accordingly, in one example, assume that the light transmittance of the liquid crystal display without the light refracting members of the present invention is 30% with 70% of light loss quantity. Then the light transmittance pertaining to the light refracting members of the present invention can be calculated as about 25% according to the following Equation 2.

$$\frac{70\%}{1.57} \times 0.57 = 25\% \quad \text{[Equation 2]}$$

Then, the total light transmittance of the liquid crystal display having the light refracting members according to the present invention is 30%+25%=55%. In other words, by providing the light refracting members of the present invention, the light transmittance of a liquid crystal display can be increased from 30% to 55% according to this one example.

In the meantime, in order to make light incident on the wirings or the black matrix refract and pass through the effective pixels of the liquid crystal display panel, a radius curvature or depth, etc. of protrusions or grooves has to be considered appropriately in the process of forming the cylindrical grooves, cylindrical protrusions, wedge-shaped grooves and the wedge-shaped protrusions.

The above-described embodiments can be applied to not only a general transmission type liquid crystal display but also a projection type display or additional transmittance type display. They may also apply to other display types such as reflective LCDs or transfective LCDs. Further, the present invention is not limited to the specific protrusions or grooves

described herein, but covers protrusions or grooves having other shapes, but corresponding to the black matrix, wirings or any other light blocking elements. For example, protrusions or grooves having a combination of circular and wedge structures such as wedge-shaped structures with rounded tips may be used as long as the structure refracts light away from the black matrix, wirings or the like. Moreover, it may be possible to provide a mixture of protrusions and grooves discussed herein along one surface of the substrate. For example, the cylindrical grooves 116 and the wedge-shaped grooves 126 may be alternatively positioned along the surface 113 of the substrate.

In the above-described substrate structure and the fabrication method thereof in accordance with the embodiments of the present invention, by including one or more light refracting members aligned with the wirings and/or the black matrix formed on the substrate, light incident onto the wirings or the black matrix can be refracted to the pixel region of the liquid crystal display panel. Accordingly, the flux of light being transmitted through the pixel region of the liquid crystal display panel can be improved significantly.

Furthermore, in the pixel region of the liquid crystal display panel, since the light refracting members are integrated into the substrate itself, unlike the conventional art, it is possible to prevent generation of reflecting elements which occurs in the conventional devices due to a refractive index difference between the materials of the micro lenses and the substrate. Accordingly, the light transmittance of the liquid crystal display of the present invention is remarkably improved.

In addition, the light refracting members are formed by etching the surface of the substrate itself. That is, the light refracting members are integrated into the substrate of the liquid crystal display. In comparison with the conventional device including micro lenses separately adhered to the substrate, then it is possible to facilitate a fabrication process and remove weight/cost increase factors of the conventional liquid crystal display panel.

Moreover, in the light refracting members in accordance with the third and fourth embodiments of the present invention, by selectively remaining the light refracting members while generally etching out the surface portion of the substrate around the light refracting members, the weight of the liquid crystal display panel can be further reduced significantly compared to the first and second embodiments of the present invention.

Accordingly, in the embodiments of the present invention, it is possible to fabricate a liquid crystal display panel capable of improving light transmittance without increasing power consumption and heat generation quantity of a back light unit.

The invention being thus described, it will be obvious that the same may be varied in many ways. Such variations are not to be regarded as a departure from the spirit and scope of the invention, and all such modifications as would be obvious to one skilled in the art are intended to be included within the scope of the following claims.

What is claimed is:

1. A method for fabricating a substrate of a liquid crystal display, comprising:

forming light blocking members on a first surface of a substrate;

forming a photosensitive film pattern on a second surface of a substrate, wherein the photosensitive film pattern has regions that selectively expose portions of the second surface of the substrate corresponding to the light blocking member, wherein the regions of the photosensitive film pattern exposing portions of the second sur-

face of the corresponding the substrate to the light blocking members have a width narrower than that of the light blocking member;

forming cylindrical grooves or wedge-shaped grooves by selectively removing the exposed portions of the second surface of the substrate through the photosensitive film pattern, wherein the cylindrical grooves or the wedge-shaped grooves are aligned on the second surface of the substrate corresponding to the light blocking members; and

removing the photosensitive film pattern.

2. The method of claim 1, wherein the light blocking members are wirings.

3. The method of claim 2, wherein the substrate is a thin film transistor (TFT) array substrate of the liquid crystal display.

4. The method of claim 2, wherein the wiring is a gate or date line patterned onto a thin film transistor (TFT) array substrate of the liquid crystal display.

5. The method of claim 1, wherein the light blocking member is a black matrix.

6. The method of claim 5, wherein the substrate is a color filter substrate of the liquid crystal display.

7. A method for fabricating a substrate of a liquid crystal display, the method comprising:

forming light blocking members on a first surface of a substrate;

forming a photosensitive film pattern on a second surface of the substrate, wherein the photosensitive film has portions that selectively mask the second surface of the substrate corresponding to the light blocking member, wherein the photosensitive film pattern corresponds with the light blocking member and has a width greater than that of the light blocking member;

forming cylindrical protrusions or wedge-shaped protrusions on the second surface of the substrate by selectively removing exposed portions the second surface of the substrate using the photosensitive film pattern as a mask, wherein the cylindrical protrusions or the wedge-shaped protrusions are aligned on the second surface of the substrate corresponding to the light blocking members; and

removing the photosensitive films.

8. The method of claim 7, wherein the light blocking members are wirings.

9. The method of claim 8, wherein the substrate is a thin film transistor (TFT) array substrate of the liquid crystal display.

10. The method of claim 8, wherein the wiring is a gate or date line patterned onto a thin film transistor (TFT) array substrate of the liquid crystal display.

11. The method of claim 7, wherein the light blocking member is a black matrix.

12. The method of claim 11, wherein the substrate is a color filter substrate of the liquid crystal display.

13. A method for fabricating a liquid crystal display, comprising:

providing a first substrate and a second substrate;

forming wirings on a first surface of the first substrate;

forming a photosensitive film pattern on a second surface of a first substrate, wherein the photosensitive film has regions that selectively expose portions of the second surface of the first substrate corresponding to the wirings, wherein the regions of the photosensitive film pattern exposing portions of the second surface of the first substrate corresponding to the wirings have a width narrower than that of the wirings;

forming cylindrical grooves or wedge-shaped grooves by selectively removing the exposed portions of the second surface of the first substrate under the openings the photosensitive film pattern, wherein the cylindrical grooves or the wedge-shaped grooves are aligned on the second surface of the substrate corresponding to the wirings;

removing the photosensitive film pattern;

forming blacking matrixes on the second substrate;

adhering the first substrate and the second substrate to face each other and have a predetermined space between them, wherein the wirings of the first substrate correspond with the black matrixes of the second substrates; and

forming a liquid crystal layer between the first and second substrates.

14. A method for fabricating a liquid crystal display, comprising:

providing a first substrate and a second substrate;

forming wirings on a first surface of the first substrate;

forming a photosensitive film pattern on a second surface of the first substrate, wherein the photosensitive film has portions that selectively mask the second surface of the first substrate corresponding to the wirings, wherein the photosensitive film pattern is aligned with the light blocking members and has a width greater than that of the wirings;

forming cylindrical protrusions or wedge-shaped protrusions on the second surface of the first substrate by selectively removing exposed portions of the second surface of the substrate using the photosensitive film pattern as a mask, wherein the cylindrical protrusions or the wedge-shaped protrusions are aligned on the second surface of the substrate corresponding to the wirings; and

removing the photosensitive film pattern;

forming blacking matrixes on the second substrate;

adhering the first substrate and the second substrate to face each other and have a predetermined space between them, wherein the wirings of the first substrate correspond with the black matrixes of the second substrates; and

forming a liquid crystal layer between the first and second substrates.

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专利名称(译)	液晶显示器的基板结构及其制造方法		
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当前申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
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摘要(译)

在基板结构及其制造方法中，与形成的布线或黑矩阵对准的光折射构件一体地形成在基板的表面上。入射在布线或黑矩阵上的光可以折射到液晶显示板的像素区域。因此，可以显著改善透过液晶显示板的像素区域的光通量。

